

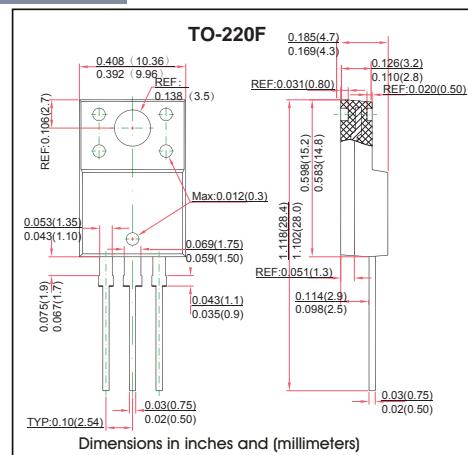
TO-220F Plastic-Encapsulate MOSFETS

FEATURE

- High Current Rating
- Lower RDS(on)
- Low Reverse Transfer
- Capacitance Fast Switching Capability
- Tighter VSD Specifications Avalanche Energy Specified
- N-Channel Power MOSFET

MECHANICAL DATA

- Case style: TO-220F molded plastic
- Mounting position: any



MAXIMUM RATINGS AND CHARACTERISTICS

@ 25°C Ambient Temperature (unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	650	V
Gate-Source Voltage	V _{GSS}	±30	
Continuous Drain Current	I _D	12	A
Pulsed Drain Current(note1)	I _{DM}	48	
Single Pulsed Avalanche Energy (note2)	E _{AS}	540	mJ
Thermal Resistance from Junction to Ambient	R _{θJA}	62.5	°C/W
Junction and Storage Temperature Range	T _J , T _{STG}	-55 ~ +150	°C
Maximum lead temperature for soldering purposes , 1/8" from case for 5 seconds	T _L	260	

MOSFET ELECTRICAL CHARACTERISTICS T_A=25°C unless otherwise specified

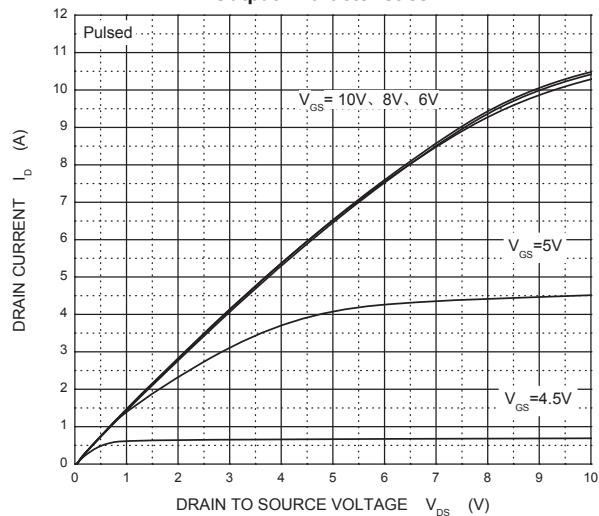
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Off characteristics						
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	650			V
Zero gate voltage drain current	I _{DSS}	V _{DS} = 650V, V _{GS} = 0V			1	μA
Gate-body leakage current (note3)	I _{GSS}	V _{DS} = 0V, V _{GS} = ±30V			±100	nA
On characteristics (note3)						
Gate-threshold voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	2.0	3.5	4.0	V
Static drain-source on-resistance	R _{DS(on)}	V _{GS} = 10V, I _D = 6A		0.7	0.85	Ω
Dynamic characteristics (note 4)						
Input capacitance	C _{iss}	V _{DS} = 25V, V _{GS} = 0V, f = 1MHz		1800		pF
Output capacitance	C _{oss}			200		
Reverse transfer capacitance	C _{rss}			25		
Switching characteristics (note1,3,4)						
Total gate charge	Q _g	V _{DS} = 520V, V _{GS} = 10V, I _D = 12A		42	54	nC
Gate-source charge	Q _{gs}			8.6		
Gate-drain charge	Q _{gd}			21		
Turn-on delay time	t _{d(on)}	V _{DD} = 325V, V _{GS} = 10V, R _G = 25Ω, I _D = 12A		30		ns
Turn-on rise time	t _r			90		
Turn-off delay time	t _{d(off)}			160		
Turn-off fall time	t _f			90		
Drain-Source Diode Characteristics						
Drain-source diode forward voltage(note3)	V _{SD}	V _{GS} = 0V, I _S = 12A			1.4	V
Maximum continuous drain-source diode forward current	I _S				12	A
Maximum pulsed drain-source diode forward current	I _{SM}				48	A

Notes :

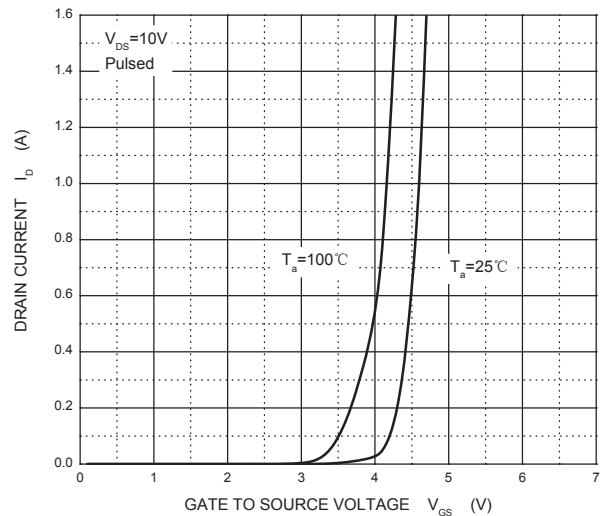
1. Repetitive Rating : Pulse width limited by maximum junction temperature
2. L = 7.5mH, I_{AS} = 12A, V_{DD} = 50V, R_G = 25Ω, Starting T_J = 25°C
3. Pulse Test : Pulse width ≤ 300μs, duty cycle ≤ 2%.
4. These parameters have no way to verify.

RATINGS AND CHARACTERISTIC CURVES

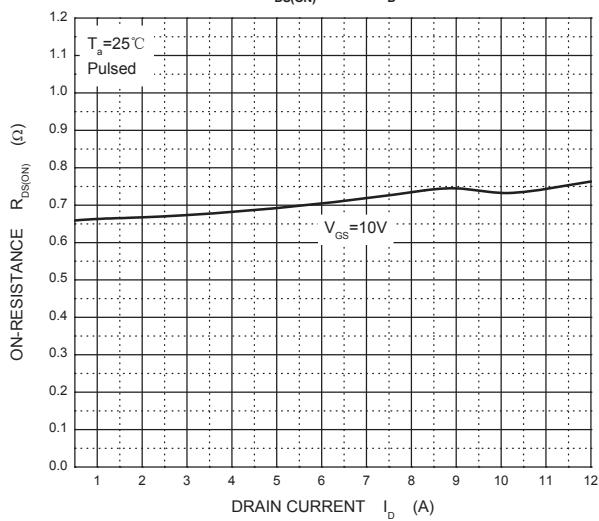
Output Characteristics



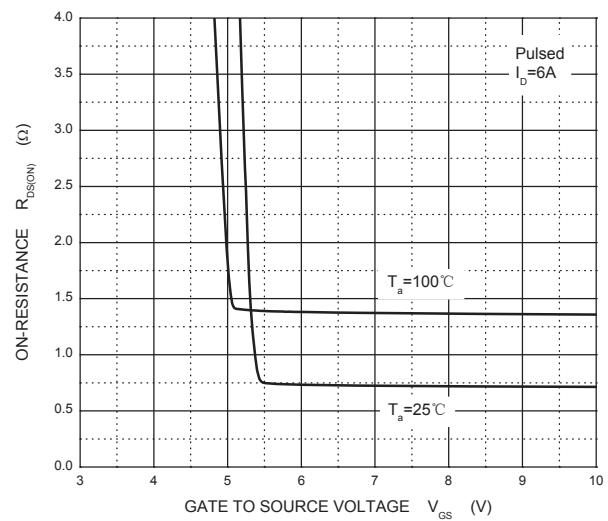
Transfer Characteristics



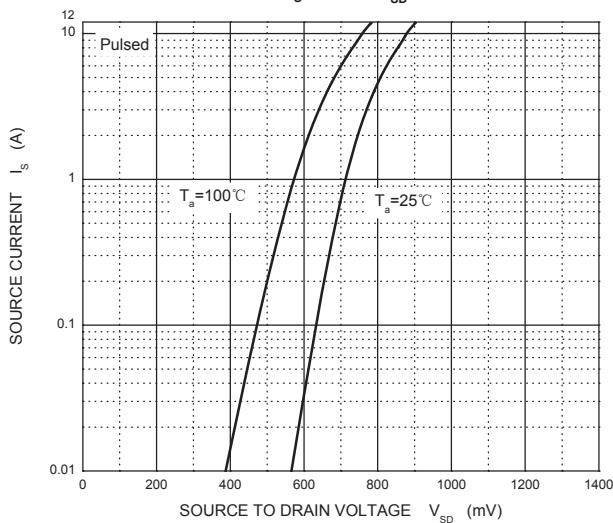
$R_{DS(ON)}$ — I_D



$R_{DS(ON)}$ — V_{GS}



I_S — V_{SD}



Threshold Voltage

